

NOTES: UNLESS OTHERWISE SPECIFIED

1. MATERIAL SPECIFICATIONS:

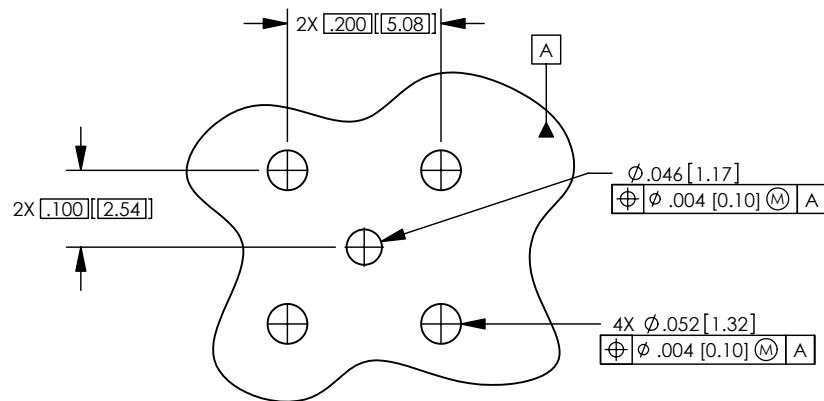
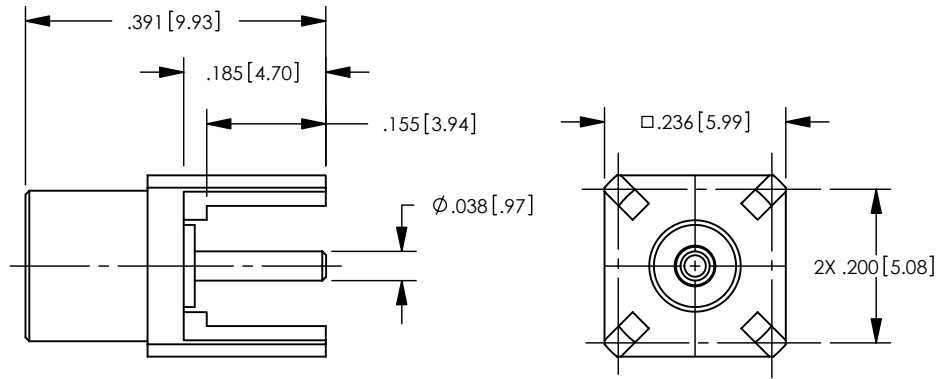
BODY & CONTACT: COPPER ALLOY
INSULATOR; TEFLON PER ASTM D1710

2. FINISH SPECIFICATIONS:

BODY: .000015 MIN. GOLD PER ASTM B4888 OVER
.000100 MIN. COPPER PER ASTM B734
CONTACT: .000030 MIN. GOLD PER ASTM B4888 OVER
.000100 MIN. COPPER PER ASTM B734

3. NON-MAGNETIC.

REV	DESCRIPTION	BY DATE	APPD
B	REVISED PER ECR-ER4061	CMB /09/30/07	CMB



RECOMENDED PCB LAYOUT
COMPONENT SIDE SHOWN

CATALOG P/N: 451-060-0046J

PER ASME Y14.5M-1994 UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN INCHES [MM] TOLERANCES: DECIMAL: .XX [X.X] ± .01 [0.3] .XXX [X.XX] ± .005 [0.13] .XXXX [X.XXX] ± .XXXX ANGLES: ± 2° SCALE: 4:1				 Winchester Electronics Corporation 62 Barnes Industrial Road North Wallingford, Connecticut 06492	
CUSTOMER DRAWING			 P.C. MOUNT, MCX JACK		
DRAWN	DATE	APPROVED	DATE	A SD451-060-0046J SHT 1 OF 1 REV B	
JED	03/11/03	SD	03/13/03		
APPROVED	DATE	APPROVED	DATE		
JEM	03/12/03	KJT	03/12/03		